

# COM Express Solder Mode

COM Express Carrier Board Standoff



## Material

Material	Stainless Steel
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## Surface Treatment

Surface Treatment	Tin Plated
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### Headquarter

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**EFCO**  
EverFine Group

Note : All product specifications are subject to change without notice

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EFCO Part Number	Part Name	Thread Size	Head Length	Suggested PCB Hole Size	Board to Board Height
40100-A00014-B.0	ECM00530-L	M2.5	5mm	Ø3.2	5mm
40100-A00017-B.0	ECM00579-L	M2.5	8mm	Ø3.2	8mm

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